## TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

## **HN3C09F**

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

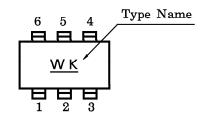
Including Two Devices in SM6 (Super Mini Type with 6 Leads)

## MAXIMUM RATINGS ( $Ta = 25^{\circ}C$ )

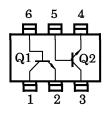
CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$v_{CBO}$	20	V
Collector-Emitter Voltage	$v_{CEO}$	12	V
Emitter-Base Voltage	$V_{EBO}$	3	V
Base Current	IB	15	mA
Collector Current	IC	30	mA
Collector Power Dissipation	PC*	300	mW
Junction Temperature	$T_{j}$	125	°C
Storage Temperature Range	$T_{ m stg}$	-55~125	°C

\*: Total

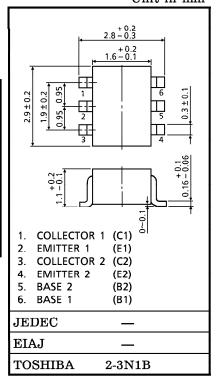
**MARKING** 



PIN ASSIGNMENT (TOP VIEW)



Unit in mm



## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	ICBO	$V_{CB}=10V, I_{E}=0$	_	_	1	$\mu$ <b>A</b>
Emitter Cut-off Current	$I_{EBO}$	$V_{EB} = 1V, I_{C} = 0$		_	1	$\mu$ <b>A</b>
DC Current Gain	$\mathbf{h_{FE}}$	$V_{CE}=5V, I_{C}=10mA$	80	_	240	_
Transition Frequency	${ m f_T}$	$V_{CE}=5V, I_{C}=10mA$	5	7	<b>—</b>	GHz
Insertion Gain	$ S_{21e} ^2$	$V_{CE}=5V$ , $I_{C}=10mA$ , $f=1GHz$	8	11.5	_	dB
Noise Figure	NF	$V_{CE}=5V$ , $I_{C}=3mA$ , $f=1GHz$	_	1.1	2	dB
Reverse Transfer Capacitance Q1	$\mathrm{C}_{\mathbf{re}}$	V <sub>CB</sub> =5V, I <sub>E</sub> =0, f=1MHz (Note)		0.45	0.9	pF
Reverse Transfer Capacitance Q2	$C_{re}$		I	0.4	0.85	pF

(Note) Cre is measured by 3 terminal method capacitance bridge.

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